

September 2014

FCP130N60

N-Channel SuperFET[®] II MOSFET 600 V, 28 A, 130 m Ω

Features

- 650 V @ T_J = 150°C
- Typ. $R_{DS(on)}$ = 112 $m\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 54 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 240 pF)
- · 100% Avalanche Tested
- · RoHS Compliant

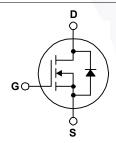
Applications

- · Telecom / Sever Power Supplies
- · Industrial Power Supplies

Description

SuperFET® II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is suitable for various AC/DC power conversion for system miniaturization and higher efficiency.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		Parameter		FCP130N60	Unit
V _{DSS}	Drain to Source Voltage			600	V
V	Gate to Source Voltage	- DC		±20	V
V_{GSS}	Gate to Source voltage	- AC	(f > 1 Hz)	±30	V
	Drain Current	- Continuous (T _C = 25°C)		28	Α
ID	Dialii Current	- Continuous (T _C = 100°C)		18	
I _{DM}	Drain Current	- Pulsed	(Note 1)	84	Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			720	mJ
I _{AR}	Avalanche Current (Note 1)		6	Α	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	2.78	mJ
dv/dt	MOSFET dv/dt			100	V/ns
uv/ut	Peak Diode Recovery dv/dt		(Note 3)	20	V/IIS
D	Bower Discipation	(T _C = 25°C)		278	W
P_{D}	Power Dissipation - Derate Above 25°C		2.2	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
T _L	Maximum Lead Temperature	Maximum Lead Temperature for Soldering,1/8" from Case for 5 Seconds			

Thermal Characteristics

Symbol	Parameter FCP130N60			
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.45	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	- 0/00	

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FCP130N60	FCP130N60	TO-220	Tube	N/A	N/A	50 units

Test Conditions

Min.

Тур.

Max.

Unit

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted. Parameter

Off Chara	acteristics					
DV	Drain to Course Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 10 \text{ mA}, T_J = 25^{\circ}\text{C}$	600	-	-	V
BV _{DSS} Drain to Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 10 \text{ mA}, T_J = 150^{\circ}\text{C}$	650	-	-	V	
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 10 mA, Referenced to 25°C	-	0.67	-	V/°C
I _{DSS} Zero Gate Voltage Drain Curren	Zoro Coto Voltago Prain Current	V _{DS} = 600 V, V _{GS} = 0 V	-	-	1	
	Zero Gate Voltage Drain Current	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_{C} = 125^{\circ}\text{C}$	-	1.3	-	μΑ
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±100	nA

On Characteristics

Symbol

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2.5	-	3.5	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 14 A	-	112	130	mΩ
9 _{FS}	Forward Transconductance	$V_{DS} = 20 \text{ V}, I_D = 14 \text{ A}$	-	26	1	S

Dynamic Characteristics

C _{iss}	Input Capacitance	V 200 V V 0 V	\ -	2700	3590	pF
C _{oss}	Output Capacitance	V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz		65	85	pF
C _{rss}	Reverse Transfer Capacitance			2.85	-	pF
C _{oss(eff.)}	Effective Output Capacitance	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$	-	240	-	pF
Q _{g(tot)}	Total Gate Charge at 10V	V _{DS} = 380 V, I _D = 14 A,	-	54	70	nC
Q_{gs}	Gate to Source Gate Charge	V _{GS} = 10 V	-	12	-	nC
Q_{gd}	Gate to Drain "Miller" Charge	(Note 4)	-	14	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	1	-	Ω

Switching Characteristics

t _{d(on)}	Turn-On Delay Time		-	25	60	ns
t _r		$V_{DD} = 380 \text{ V}, I_{D} = 14 \text{ A},$	-	16	42	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_g = 4.7 Ω	-/	65	140	ns
t _f	Turn-Off Fall Time	(Note 4)	1	4	18	ns

Drain-Source Diode Characteristics

Is	Maximum Continuous Drain to Source Diode Forward Current			-	28	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current			-	84	Α
V_{SD}	Drain to Source Diode Forward Voltage V _{GS} = 0 V, I _{SD} = 14 A		-	-	1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 14 A,	-	376	-	ns
Q _{rr}	Reverse Recovery Charge dI _F /dt = 100 A/μs		-	7.6	-	μС

- 1. Repetitive rating: pulse width limited by maximum junction temperature.
- 2. I_{AS} = 6 A, V_{DD} = 50 V, R_{G} = 25 Ω , starting T_{J} = 25°C.
- 3. I $_{SD} \leq$ 14 A, di/dt \leq 200 A/µs, V $_{DD} \leq$ BV $_{DSS},$ starting T $_{J}$ = 25°C.
- 4. Essentially independent of operating temperature typical characteristics.

Typical Performance Characteristics

Figure 1. On-Region Characteristics

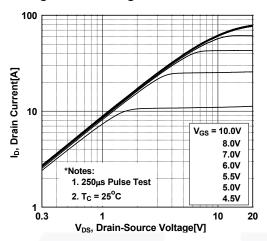


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

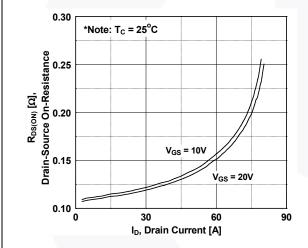


Figure 5. Capacitance Characteristics

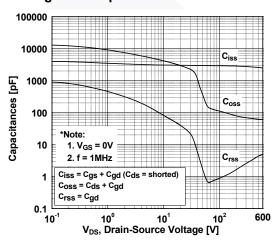


Figure 2. Transfer Characteristics

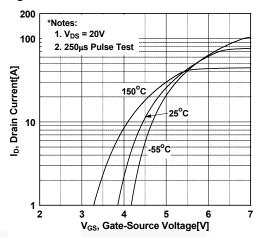


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

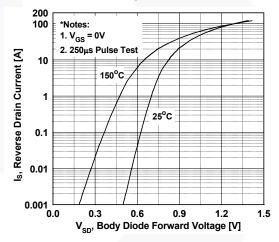
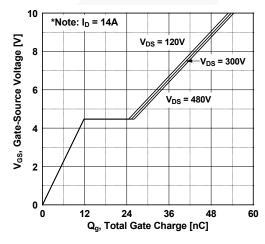


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

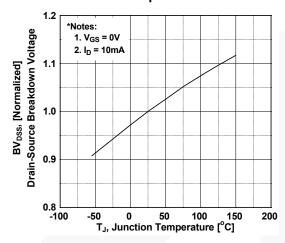


Figure 9. Maximum Safe Operating Area

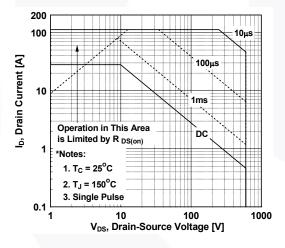


Figure 11. Eoss vs. Drain to Source Voltage

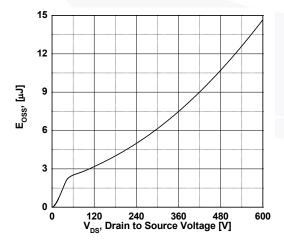


Figure 8. On-Resistance Variation vs. Temperature

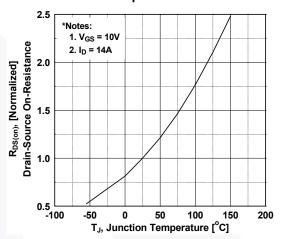
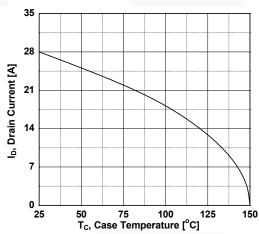
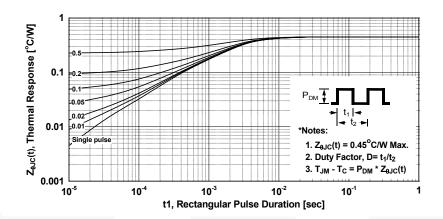


Figure 10. Maximum Drain Current vs. Case Temperature



Typical Performance Characteristics (Continued)

Figure 12. Transient Thermal Response Curve



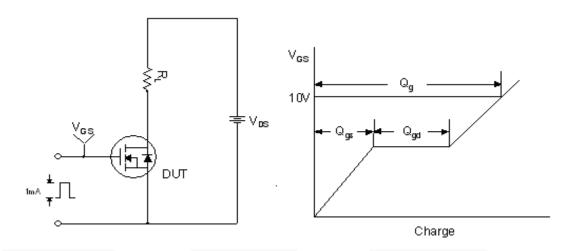


Figure 13. Gate Charge Test Circuit & Waveform

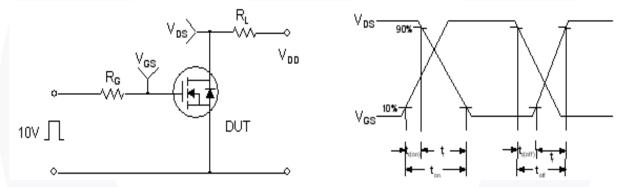


Figure 14. Resistive Switching Test Circuit & Waveforms

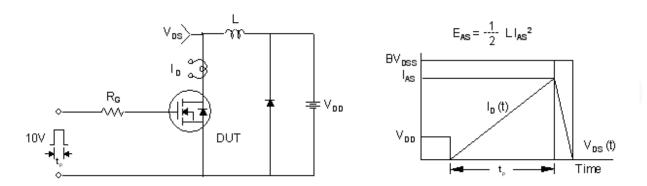


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

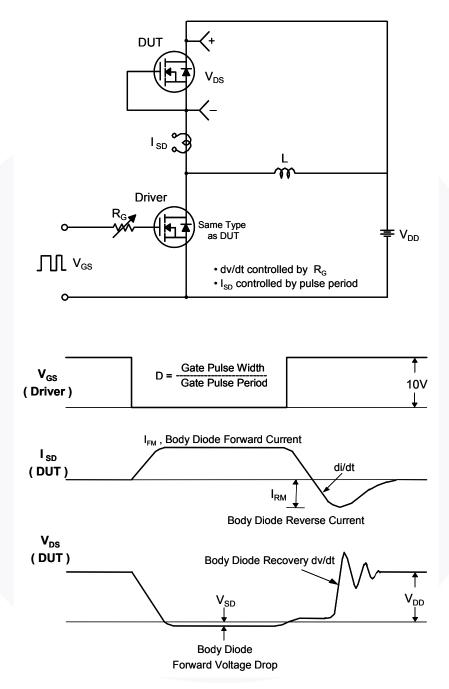
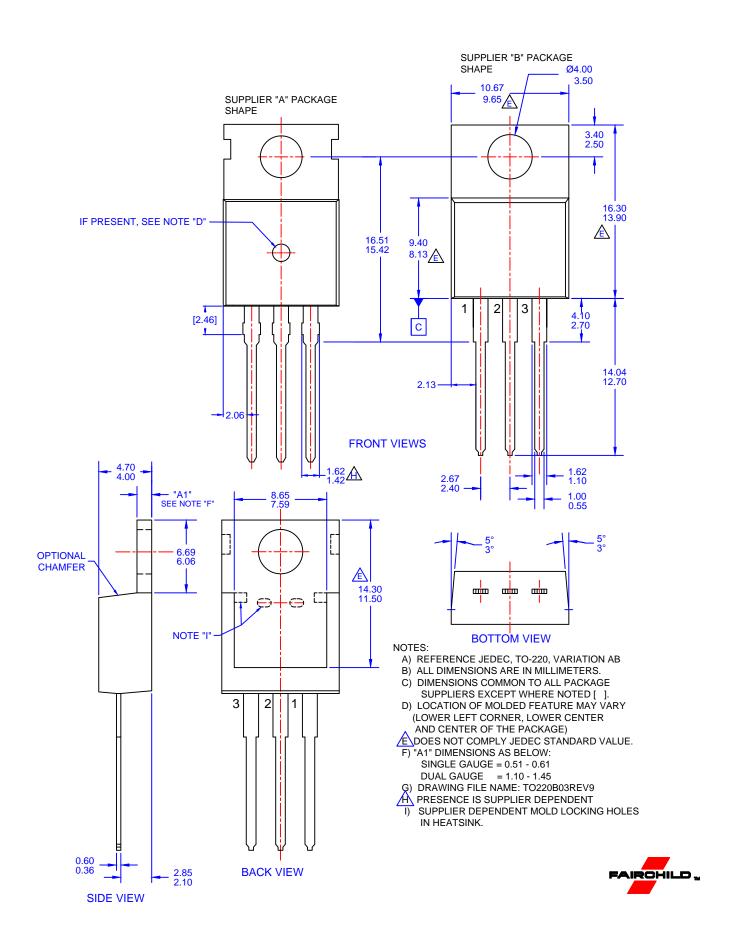


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms







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Deminition of Terms		
Datasheet Identification		Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
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